Vishay Siliconix

Si7252ADP

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Dual N-Channel 100 V (D-S) MOSFET



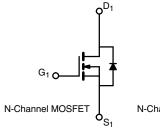
$\begin{tabular}{|c|c|c|c|} \hline PRODUCT SUMMARY \\ \hline V_{DS}(V) & 100 \\ \hline R_{DS(on)} max. (\Omega) at V_{GS} = 10 V & 0.0186 \\ \hline R_{DS(on)} max. (\Omega) at V_{GS} = 7.5 V & 0.0225 \\ \hline Q_g typ. (nC) & 13.1 \\ \hline I_D (A) & 28.7 \ ^a \\ \hline Configuration & Dual \\ \hline \end{tabular}$

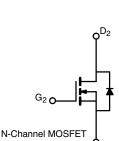
FEATURES

- TrenchFET[®] power MOSFET
- PWM optimized
- 100 % R_a and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

System power DC/DC





ORDERING INFORMATION	
Package	PowerPAK SO-8
l ead (Pb)-free and halogen-free	Si7252ADP-T1-GE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	100	V	
Gate-source voltage		V _{GS}	± 20	v	
	T _C = 25 °C		28.7 ^a		
Continuous drain surrant (T 150 °C)	T _C = 70 °C	1 , [23 ^a		
Continuous drain current ($T_J = 150 \ ^{\circ}C$)	T _A = 25 °C		9.3 ^a		
	T _A = 70 °C	1	7.4 ^a	A	
Pulsed drain current		I _{DM}	70	7	
Courses drain current diada current	T _C = 25 °C		30.7		
Source-drain current diode current	T _A = 25 °C	ls –	3.3 ^{b, c}		
	T _C = 25 °C		33.8		
Maximum power dissipation	T _C = 70 °C		21.6	w	
	T _A = 25 °C	P _D —	3.6 ^{b, c}	vv	
	T _A = 70 °C	1	2.3 ^{b, c}		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	℃	
Soldering recommendations (peak temperature) ^{d, e}			260		

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient b, f	t ≤ 10 s	R _{thJA}	28	35	°C/W
Maximum junction-to-case (drain)	Steady state	R _{thJC}	3	3.7	0/10

Notes

a. Package limited

b. Surface mounted on 1" x 1" FR4 board

c. t = 10 s

d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

f. Maximum under steady state conditions is 85 °C/W

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static			•			
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	100	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	I _D = 10 mA	-	81	-	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-7.4	-	mV/°C
Gate threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	2	-	4	V
Gate-body leakage	I _{GSS}	$V_{DS}=0~V,~V_{GS}=\pm~20~V$	-	-	100	nA
Zere gete veltege drein eurrent	I _{DSS} -	$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1	
Zero gate voltage drain current		$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 85 ^{\circ}\text{C}$	-	-	10	μA
On-state drain current ^b	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$		-	-	Α
Durain ann an stata unaistean a b	_	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	0.0155	0.0186	0
Drain-source on-state resistance b	R _{DS(on)}	$V_{GS} = 7.5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	0.0175	0.0225	Ω
Forward transconductance b	9 _{fs}	V _{DS} = 15 V, I _D = 10 A	-	22	-	S
Dynamic ^a			•			
Input capacitance	C _{iss}		-	1266	-	pF
Output capacitance	C _{oss}	$V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	-	123	-	
Reverse transfer capacitance	C _{rss}		-	6	-	
Total gate charge	Qg	$V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	17.4	26.5	
			-	13.1	20	
Gate-source charge	Q _{gs}	$V_{DS} = 50 \text{ V}, V_{GS} = 7.5 \text{ V}, I_D = 10 \text{ A}$	-	7.1	-	nC
Gate-drain charge	Q _{gd}		-	2.3	-	
Gate resistance	R _g	f = 1 MHz	0.2	0.75	1.3	Ω
Turn-on delay time	t _{d(on)}		-	12	24	
Rise time	t _r	$V_{DD} = 50 \text{ V}, \text{ R}_{1} = 5 \Omega$	-	6	12	1
Turn-off delay time	t _{d(off)}	$V_{DD} = 50 \text{ V}, \text{ H}_{\text{L}} = 5 \Omega$ $I_{\text{D}} \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 7.5 \text{ V}, \text{ H}_{\text{g}} = 1 \Omega$		15	30	1
Fall time	t _f		-	5	10	
Turn-on delay time	t _{d(on)}		-	11	22	- ns -
Rise time	t _r	V_{DD} = 50 V, R_L = 5 Ω	-	5	10	
Turn-off delay time	t _{d(off)}	$I_D \cong 10$ Å, $V_{GEN} = 10$ V, $R_g = 1$ Ω	-	16	32	
Fall time	t _f		-	5	10	
Drain-Source Body Diode Characteristics	;					
Continuous source-drain diode Current	IS	T _C = 25 °C	-	-	30.7	^
Pulse diode forward current ^a	I _{SM}		-	-	70	A
Body diode voltage	V _{SD}	I _S = 5 A	-	0.78	1.1	V
Body diode reverse recovery time	t _{rr}		-	37	74	ns
Body diode reverse recovery charge	Q _{rr}	I _F = 5 A, di/dt = 100 A/µs,	-	53	106	nC
Reverse recovery fall time	t _a	$T_J = 25 \ ^\circ C$	-	27	-	
Reverse recovery rise time	t _b		-	10	-	ns

Notes

a. Guaranteed by design, not subject to production testing

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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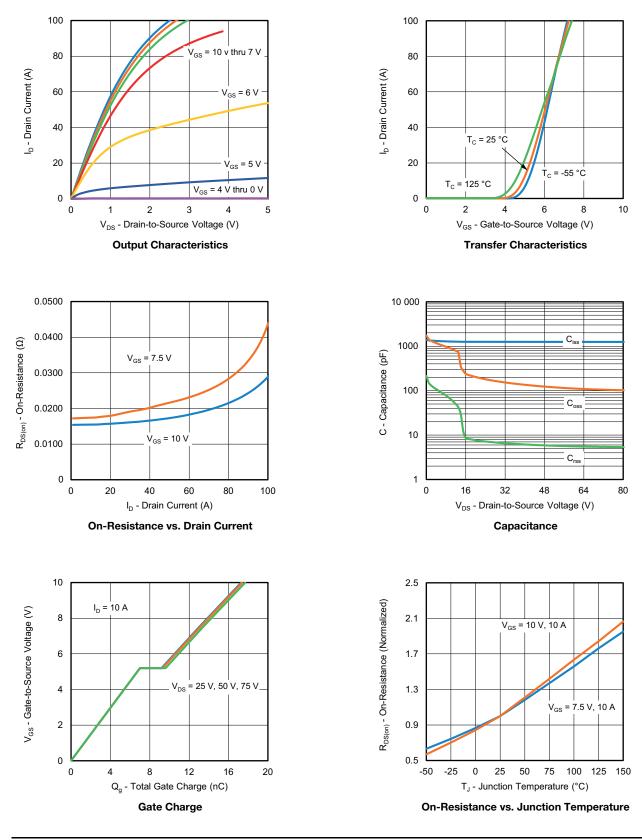
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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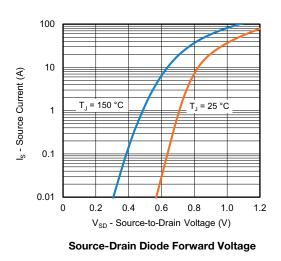
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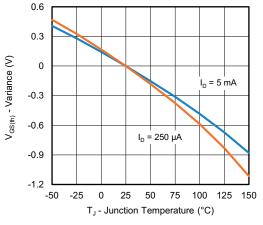


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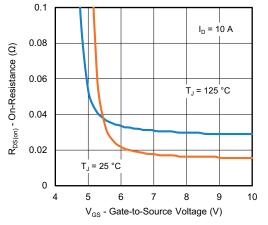
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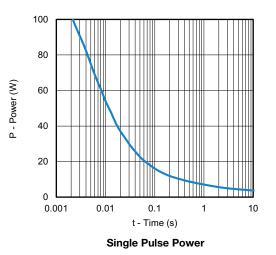


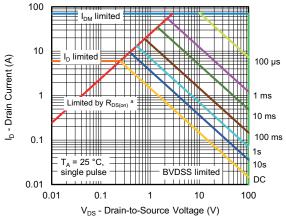






On-Resi.0stance vs. Gate-to-Source Voltage





Safe Operating Area, Junction-to-Ambient

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

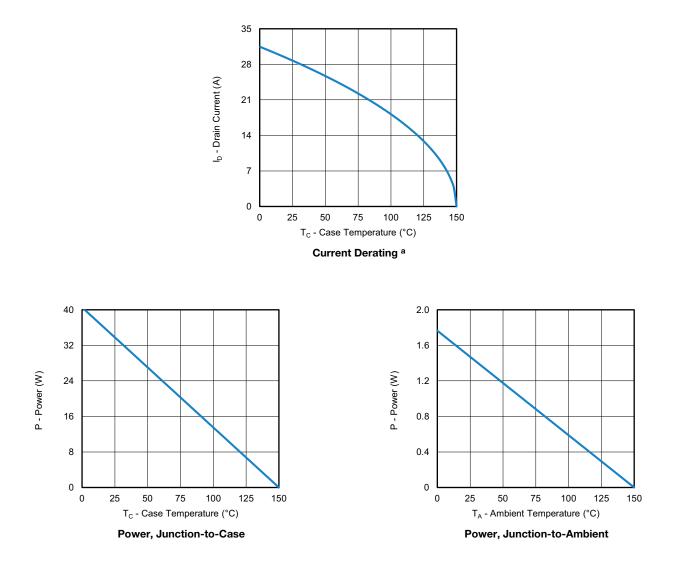
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Note

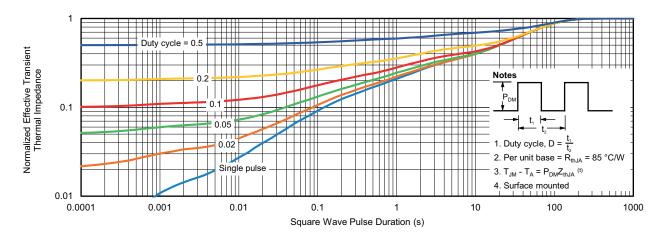
a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



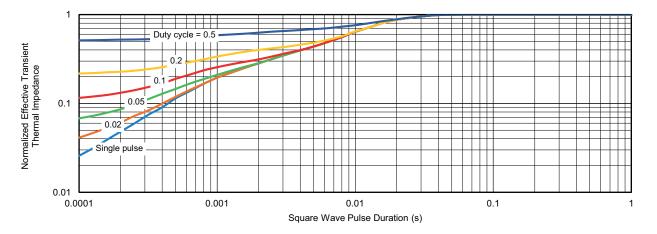
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg279298.

D2

E3

Backside View of Dual Pad



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PowerPAK[®] SO-8, (Single/Dual)



Notes

1. Inch will govern.

2 Dimensions exclusive of mold gate burrs.

3. Dimensions exclusive of mold flash and cutting burrs.

DIM.		MILLIMETERS			INCHES			
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX		
А	0.97	1.04	1.12	0.038	0.041	0.044		
A1		-	0.05	0	-	0.00		
b	0.33	0.41	0.51	0.013	0.016	0.02		
С	0.23	0.28	0.33	0.009	0.011	0.01		
D	5.05	5.15	5.26	0.199	0.203	0.20		
D1	4.80	4.90	5.00	0.189	0.193	0.19		
D2	3.56	3.76	3.91	0.140	0.148	0.154		
D3	1.32	1.50	1.68	0.052	0.059	0.066		
D4		0.57 typ.			0.0225 typ.			
D5		3.98 typ. 0.157 typ.						
E	6.05	6.15	6.25	0.238	0.242	0.246		
E1	5.79	5.89	5.99	0.228	0.232	0.23		
E2	3.48	3.66	3.84	0.137	0.144	0.15		
E3	3.68	3.78	3.91	0.145	0.149	0.154		
E4		0.75 typ.			0.030 typ.			
е		1.27 BSC		0.050 BSC				
К		1.27 typ.			0.050 typ.			
K1	0.56	-	-	0.022	-	-		
Н	0.51	0.61	0.71	0.020	0.024	0.028		
L	0.51	0.61	0.71	0.020	0.024	0.028		
L1	0.06	0.13	0.20	0.002	0.005	0.008		
θ	0°	-	12°	0°	-	12°		
W	0.15	0.25	0.36	0.006	0.010	0.014		
М		0.125 typ.			0.005 typ.			

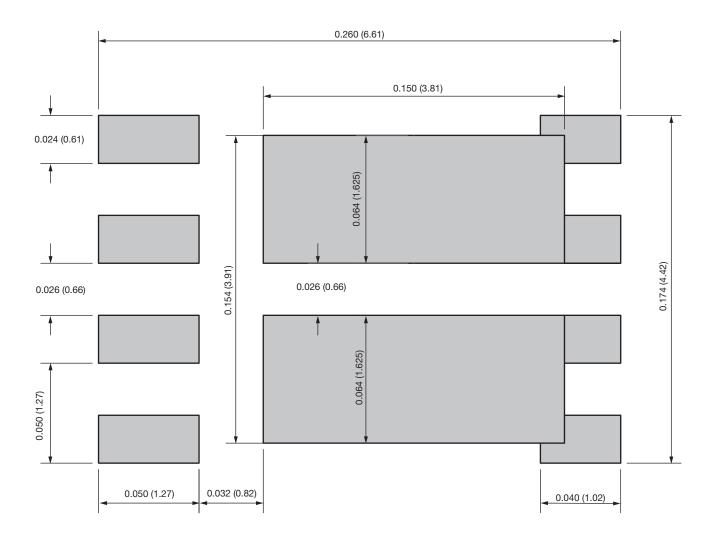
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PAD Pattern

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Recommended Land Pattern PowerPAK® SO-8 Dual



Note

• Dimensions in inches (millimeters)

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Document Number: 72600



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